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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/528,160	03/17/2005	Ichiro Hazeyama	Q86110	6481
23373	7590 03/17/2006	EXAMINER		INER
SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W.			TAYLOR, EARL N	
SUITE 800			ART UNIT	PAPER NUMBER
WASHINGT	ON, DC 20037		2818	

DATE MAILED: 03/17/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	·	Application No.	Applicant(s)			
Office Action Summary		10/528,160	HAZEYAMA ET AL.			
		Examiner	Art Unit			
		Earl N. Taylor	2818			
	The MAILING DATE of this communication app	·	orrespondence address			
Period fo	* *	·				
WHIC - Exter after - If NO - Failu Any (	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 16(a). In no event, however, may a reply be tim iiii apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONEI	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
1)⊠	Responsive to communication(s) filed on 17 M	arch 2005 - 3 October 2005.	·			
· —	This action is <b>FINAL</b> . 2b)⊠ This action is non-final.					
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Dispositi	on of Claims					
4)⊠	Claim(s) <u>1-8</u> is/are pending in the application.	,				
·	4a) Of the above claim(s) is/are withdrawn from consideration.					
5)🖂	5)⊠ Claim(s) <u>6</u> is/are allowed.					
•	6)⊠ Claim(s) <u>1-3,5 and 8</u> is/are rejected.					
· ·	Claim(s) <u>4 and 7</u> is/are objected to.	1				
8)[_]	Claim(s) are subject to restriction and/or	r election requirement.	•			
Applicati	on Papers					
9)	The specification is objected to by the Examine	r.				
10)⊠ The drawing(s) filed on <u>17 March 2005</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority L	ınder 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a)⊠ All b)□ Some * c)□ None of:						
1. Certified copies of the priority documents have been received.						
<ul> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage</li> </ul>						
	application from the International Bureau					
* See the attached detailed Office action for a list of the certified copies not received.						
	•					
Attachmen	t(s)		•			
_	e of References Cited (PTO-892)	4) Interview Summary				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Notice of Draftsperson's Patent Drawing Review (PTO-948)  Paper No(s)/Mail Date  Notice of Informal Patent Application (PTO-152)						
	r No(s)/Mail Date	6) Other:				

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#### **DETAILED ACTION**

### Priority

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

#### Information Disclosure Statement

This office acknowledges receipt of the following items from the applicant:

Information Disclosure Statement (IDS) filed on 17 March 2005. The references cited on the PTOL 1449 form have been considered.

## Claim Objections

Claim 7 objected to because of the following informalities: Claim 7 recites "of said" and should read --of said--. Appropriate correction is required.

### Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States

Claims 1 and 2 are rejected under 35 U.S.C. 102(b) as being anticipated by Masami (JP Pat. 08-340021).

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Referring to Claim 1, Masami discloses, in Fig. 1, a semiconductor package comprising: a semiconductor device (2) with one or more device-side electrodes (4) being formed on a circuit-bearing surface; and a flexible substrate having a patterned wiring (32) and a polyimide layer which functions as a thermoplastic insulating layer (30, 31) formed on either or both sides of the patterned wiring (32) (par. 45 and 46), the flexible substrate being bent around said semiconductor device (2), wherein: said flexible substrate has a first electrode (17) provided on said semiconductor device-side surface of said flexible substrate, the first electrode (17) being connected to said device-side electrode (4) of said semiconductor device and sealed by said thermoplastic insulating layer (30, 31), and a second electrode (21, 23) provided on a surface different from the surface on which said first electrode (17) is provided; and said flexible substrate has at least two or more layers of patterned wiring formed thereon (Fig. 1; abstract; par. 58 and 59).

Referring to Claim 2, Masami discloses all of the limitations of Claim 1 wherein said flexible substrate has a groove (100) as shown below in Fig. 1.

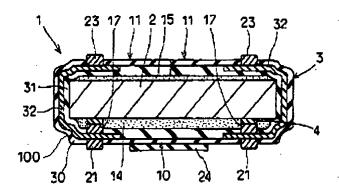


Figure 1: Includes reference character 100 for clarity

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Referring to Claim 8, Masami discloses all of the limitations of Claim 1 wherein a a plurality of semiconductor packages form stacked semiconductor package and are electrically connected via said electrodes and three-dimensionally stacked in layers (see Drawings 8, 9 and 12-17).

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 3 and 5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Masami as applied to Claim 2 above, and further in view of Yoichiro (JP Pat. 2001-308261).

Referring to Claims 3 and 5, Masami discloses all of the limitations of Claims 1 and 2 but does not disclose wherein said flexible substrate has a cavity formed on said flexible substrate so as to accommodate said semiconductor device in said cavity portion. Yoichiro discloses, Fig. 2-5, a technique in which a cavity is formed in a flexible substrate, and a semiconductor device is accommodated in the cavity (par. 12-28). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to apply the technique taught by Yoichiro wherein a cavity is formed in a flexible substrate, and the semiconductor device as taught by Masami is

accommodated in the cavity because this combination is superior in the ease of a threedimensional assembly and the repair workability (abstract).

### Allowable Subject Matter

Claim 4 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claim 6 is allowed.

Claim 7 would be allowed pending minor claim objection.

The following is an examiner's statement of reasons for allowance:

Referring to Claim 4, the prior art taken alone or in combination neither teach nor makes obvious the claimed invention wherein said flexible substrate includes portions which are folded back to be directly adhered to each other, the folded-back portions defining a recessed portion, said semiconductor device being disposed within said recessed portion.

Referring to Claim 6, the prior art taken alone or in combination neither teach nor makes obvious the claimed invention wherein said flexible substrate includes portions which are folded back at bends to be directly adhered to each other.

Referring to Claim 7, the prior art taken alone or in combination neither teach nor makes obvious the claimed invention wherein the semiconductor device is

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accommodated in a recessed portion created by the portions of said flexible substrate

being folded back to be directly adhered to each other.

Any comments considered necessary by applicant must be submitted no later

than the payment of the issue fee and, to avoid processing delays, should preferably

accompany the issue fee. Such submissions should be clearly labeled "Comments on

Statement of Reasons for Allowance."

Telephone / Fax Information

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Earl N. Taylor whose telephone number is (571) 272-

8894. The examiner can normally be reached on Monday-Friday from 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, David Nelms can be reached on (571) 272-1787. The fax phone number for

the organization where this application or proceeding is assigned is (571) 273-8300.

Information regarding the status of an application may be obtained from the

Patent Application Information Retrieval (PAIR) system. Status information for

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you have questions on access to the Private PAIR system, contact the Electronic

Business Center (EBC) at 866-217-9197 (toll-free).

Examiner: Earl N. Taylor

Supervisory Patent Examiner Technology Center 2800